





 LAMB POLICY HOME

| Title: Medium board, | rd, base board with | medium board and st | base board with medium board and structure part and method for producing medium boar |
|----------------------|---------------------|--|--|
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Classification

Abstract

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mounted on at least one of said first and second faces, said semiconductor device having a coefficient of thermal expansion that is equal to or plurality of through holes through which said first and second faces communicate with each other, said intermediate board body containing an inorganic insulating material; and a plurality of conductor columns filling said through holes and containing a conductive metal, said conductor larger than 2.0 ppm/ DEG C. and smaller than 5.0 ppm/ DEG C., and having surface mount terminals, said intermediate board body having a An intermediate board comprising: an intermediate board body having first and second faces wherein a semiconductor device is to be columns being to be connected with said surface mount terminals.



